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### Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

Product Status	Active
Number of LABs/CLBs	250540
Number of Logic Elements/Cells	660000
Total RAM Bits	49610752
Number of I/O	396
Number of Gates	-
Voltage - Supply	0.87V ~ 0.93V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 100°C (TJ)
Package / Case	1152-BBGA, FCBGA
Supplier Device Package	1152-FCBGA (35x35)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/intel/10ax066k4f35e3lg">https://www.e-xfl.com/product-detail/intel/10ax066k4f35e3lg</a>



## Intel® Arria® 10 Device Overview

The Intel® Arria® 10 device family consists of high-performance and power-efficient 20 nm mid-range FPGAs and SoCs.

Intel Arria 10 device family delivers:

- Higher performance than the previous generation of mid-range and high-end FPGAs.
- Power efficiency attained through a comprehensive set of power-saving technologies.

The Intel Arria 10 devices are ideal for high performance, power-sensitive, midrange applications in diverse markets.

**Table 1. Sample Markets and Ideal Applications for Intel Arria 10 Devices**

Market	Applications
Wireless	<ul style="list-style-type: none"> <li>• Channel and switch cards in remote radio heads</li> <li>• Mobile backhaul</li> </ul>
Wireline	<ul style="list-style-type: none"> <li>• 40G/100G muxponders and transponders</li> <li>• 100G line cards</li> <li>• Bridging</li> <li>• Aggregation</li> </ul>
Broadcast	<ul style="list-style-type: none"> <li>• Studio switches</li> <li>• Servers and transport</li> <li>• Videoconferencing</li> <li>• Professional audio and video</li> </ul>
Computing and Storage	<ul style="list-style-type: none"> <li>• Flash cache</li> <li>• Cloud computing servers</li> <li>• Server acceleration</li> </ul>
Medical	<ul style="list-style-type: none"> <li>• Diagnostic scanners</li> <li>• Diagnostic imaging</li> </ul>
Military	<ul style="list-style-type: none"> <li>• Missile guidance and control</li> <li>• Radar</li> <li>• Electronic warfare</li> <li>• Secure communications</li> </ul>

### Related Information

#### Intel Arria 10 Device Handbook: Known Issues

Lists the planned updates to the *Intel Arria 10 Device Handbook* chapters.



## Key Advantages of Intel Arria 10 Devices

**Table 2. Key Advantages of the Intel Arria 10 Device Family**

Advantage	Supporting Feature
Enhanced core architecture	<ul style="list-style-type: none"><li>Built on TSMC's 20 nm process technology</li><li>60% higher performance than the previous generation of mid-range FPGAs</li><li>15% higher performance than the fastest previous-generation FPGA</li></ul>
High-bandwidth integrated transceivers	<ul style="list-style-type: none"><li>Short-reach rates up to 25.8 Gigabits per second (Gbps)</li><li>Backplane capability up to 12.5 Gbps</li><li>Integrated 10GBASE-KR and 40GBASE-KR4 Forward Error Correction (FEC)</li></ul>
Improved logic integration and hard IP blocks	<ul style="list-style-type: none"><li>8-input adaptive logic module (ALM)</li><li>Up to 65.6 megabits (Mb) of embedded memory</li><li>Variable-precision digital signal processing (DSP) blocks</li><li>Fractional synthesis phase-locked loops (PLLs)</li><li>Hard PCI Express Gen3 IP blocks</li><li>Hard memory controllers and PHY up to 2,400 Megabits per second (Mbps)</li></ul>
Second generation hard processor system (HPS) with integrated ARM* Cortex*-A9* MPCore* processor	<ul style="list-style-type: none"><li>Tight integration of a dual-core ARM Cortex-A9 MPCore processor, hard IP, and an FPGA in a single Intel Arria 10 system-on-a-chip (SoC)</li><li>Supports over 128 Gbps peak bandwidth with integrated data coherency between the processor and the FPGA fabric</li></ul>
Advanced power savings	<ul style="list-style-type: none"><li>Comprehensive set of advanced power saving features</li><li>Power-optimized MultiTrack routing and core architecture</li><li>Up to 40% lower power compared to previous generation of mid-range FPGAs</li><li>Up to 60% lower power compared to previous generation of high-end FPGAs</li></ul>

## Summary of Intel Arria 10 Features

**Table 3. Summary of Features for Intel Arria 10 Devices**

Feature	Description
Technology	<ul style="list-style-type: none"><li>TSMC's 20-nm SoC process technology</li><li>Allows operation at a lower <math>V_{CC}</math> level of 0.82 V instead of the 0.9 V standard <math>V_{CC}</math> core voltage</li></ul>
Packaging	<ul style="list-style-type: none"><li>1.0 mm ball-pitch FINELINE BGA packaging</li><li>0.8 mm ball-pitch Ultra FINELINE BGA packaging</li><li>Multiple devices with identical package footprints for seamless migration between different FPGA densities</li><li>Devices with compatible package footprints allow migration to next generation high-end Stratix® 10 devices</li><li>RoHS, leaded<sup>(1)</sup>, and lead-free (Pb-free) options</li></ul>
High-performance FPGA fabric	<ul style="list-style-type: none"><li>Enhanced 8-input ALM with four registers</li><li>Improved multi-track routing architecture to reduce congestion and improve compilation time</li><li>Hierarchical core clocking architecture</li><li>Fine-grained partial reconfiguration</li></ul>
Internal memory blocks	<ul style="list-style-type: none"><li>M20K—20-Kb memory blocks with hard error correction code (ECC)</li><li>Memory logic array block (MLAB)—640-bit memory</li></ul>
continued...	

(1) Contact Intel for availability.



Feature	Description	
Embedded Hard IP blocks	Variable-precision DSP	<ul style="list-style-type: none"><li>• Native support for signal processing precision levels from 18 x 19 to 54 x 54</li><li>• Native support for 27 x 27 multiplier mode</li><li>• 64-bit accumulator and cascade for systolic finite impulse responses (FIRs)</li><li>• Internal coefficient memory banks</li><li>• Preadder/subtractor for improved efficiency</li><li>• Additional pipeline register to increase performance and reduce power</li><li>• Supports floating point arithmetic:<ul style="list-style-type: none"><li>— Perform multiplication, addition, subtraction, multiply-add, multiply-subtract, and complex multiplication.</li><li>— Supports multiplication with accumulation capability, cascade summation, and cascade subtraction capability.</li><li>— Dynamic accumulator reset control.</li><li>— Support direct vector dot and complex multiplication chaining multiply floating point DSP blocks.</li></ul></li></ul>
	Memory controller	DDR4, DDR3, and DDR3L
	PCI Express*	PCI Express (PCIe*) Gen3 (x1, x2, x4, or x8), Gen2 (x1, x2, x4, or x8) and Gen1 (x1, x2, x4, or x8) hard IP with complete protocol stack, endpoint, and root port
	Transceiver I/O	<ul style="list-style-type: none"><li>• 10GBASE-KR/40GBASE-KR4 Forward Error Correction (FEC)</li><li>• PCS hard IPs that support:<ul style="list-style-type: none"><li>— 10-Gbps Ethernet (10GbE)</li><li>— PCIe PIPE interface</li><li>— Interlaken</li><li>— Gbps Ethernet (GbE)</li><li>— Common Public Radio Interface (CPRI) with deterministic latency support</li><li>— Gigabit-capable passive optical network (GPON) with fast lock-time support</li></ul></li><li>• 13.5G JESD204b</li><li>• 8B/10B, 64B/66B, 64B/67B encoders and decoders</li><li>• Custom mode support for proprietary protocols</li></ul>
Core clock networks	<ul style="list-style-type: none"><li>• Up to 800 MHz fabric clocking, depending on the application:<ul style="list-style-type: none"><li>— 667 MHz external memory interface clocking with 2,400 Mbps DDR4 interface</li><li>— 800 MHz LVDS interface clocking with 1,600 Mbps LVDS interface</li></ul></li><li>• Global, regional, and peripheral clock networks</li><li>• Clock networks that are not used can be gated to reduce dynamic power</li></ul>	
Phase-locked loops (PLLs)	<ul style="list-style-type: none"><li>• High-resolution fractional synthesis PLLs:<ul style="list-style-type: none"><li>— Precision clock synthesis, clock delay compensation, and zero delay buffering (ZDB)</li><li>— Support integer mode and fractional mode</li><li>— Fractional mode support with third-order delta-sigma modulation</li></ul></li><li>• Integer PLLs:<ul style="list-style-type: none"><li>— Adjacent to general purpose I/Os</li><li>— Support external memory and LVDS interfaces</li></ul></li></ul>	
FPGA General-purpose I/Os (GPIOs)	<ul style="list-style-type: none"><li>• 1.6 Gbps LVDS—every pair can be configured as receiver or transmitter</li><li>• On-chip termination (OCT)</li><li>• 1.2 V to 3.0 V single-ended LVTTTL/LVCMOS interfacing</li></ul>	
External Memory Interface	<ul style="list-style-type: none"><li>• Hard memory controller— DDR4, DDR3, and DDR3L support<ul style="list-style-type: none"><li>— DDR4—speeds up to 1,200 MHz/2,400 Mbps</li><li>— DDR3—speeds up to 1,067 MHz/2,133 Mbps</li></ul></li><li>• Soft memory controller—provides support for RLDRAM 3<sup>(2)</sup>, QDR IV<sup>(2)</sup>, and QDR II+</li></ul>	
continued...		



Feature	Description	
Low-power serial transceivers	<ul style="list-style-type: none"><li>Continuous operating range:<ul style="list-style-type: none"><li>Intel Arria 10 GX—1 Gbps to 17.4 Gbps</li><li>Intel Arria 10 GT—1 Gbps to 25.8 Gbps</li></ul></li><li>Backplane support:<ul style="list-style-type: none"><li>Intel Arria 10 GX—up to 12.5</li><li>Intel Arria 10 GT—up to 12.5</li></ul></li><li>Extended range down to 125 Mbps with oversampling</li><li>ATX transmit PLLs with user-configurable fractional synthesis capability</li><li>Electronic Dispersion Compensation (EDC) support for XFP, SFP+, QSFP, and CFP optical module</li><li>Adaptive linear and decision feedback equalization</li><li>Transmitter pre-emphasis and de-emphasis</li><li>Dynamic partial reconfiguration of individual transceiver channels</li></ul>	
HPS (Intel Arria 10 SX devices only)	Processor and system	<ul style="list-style-type: none"><li>Dual-core ARM Cortex-A9 MPCore processor—1.2 GHz CPU with 1.5 GHz overdrive capability</li><li>256 KB on-chip RAM and 64 KB on-chip ROM</li><li>System peripherals—general-purpose timers, watchdog timers, direct memory access (DMA) controller, FPGA configuration manager, and clock and reset managers</li><li>Security features—anti-tamper, secure boot, Advanced Encryption Standard (AES) and authentication (SHA)</li><li>ARM CoreSight* JTAG debug access port, trace port, and on-chip trace storage</li></ul>
	External interfaces	<ul style="list-style-type: none"><li>Hard memory interface—Hard memory controller (2,400 Mbps DDR4, and 2,133 Mbps DDR3), Quad serial peripheral interface (QSPI) flash controller, NAND flash controller, direct memory access (DMA) controller, Secure Digital/MultiMediaCard (SD/MMC) controller</li><li>Communication interface— 10/100/1000 Ethernet media access control (MAC), USB On-The-Go (OTG) controllers, I<sup>2</sup>C controllers, UART 16550, serial peripheral interface (SPI), and up to 62 HPS GPIO interfaces (48 direct-share I/Os)</li></ul>
	Interconnects to core	<ul style="list-style-type: none"><li>High-performance ARM AMBA* AXI bus bridges that support simultaneous read and write</li><li>HPS-FPGA bridges—include the FPGA-to-HPS, HPS-to-FPGA, and lightweight HPS-to-FPGA bridges that allow the FPGA fabric to issue transactions to slaves in the HPS, and vice versa</li><li>Configuration bridge that allows HPS configuration manager to configure the core logic via dedicated 32-bit configuration port</li><li>FPGA-to-HPS SDRAM controller bridge—provides configuration interfaces for the multiport front end (MPFE) of the HPS SDRAM controller</li></ul>
Configuration	<ul style="list-style-type: none"><li>Tamper protection—comprehensive design protection to protect your valuable IP investments</li><li>Enhanced 256-bit advanced encryption standard (AES) design security with authentication</li><li>Configuration via protocol (CvP) using PCIe Gen1, Gen2, or Gen3</li></ul>	
continued...		

<sup>(2)</sup> Intel Arria 10 devices support this external memory interface using hard PHY with soft memory controller.



## Available Options

Figure 1. Sample Ordering Code and Available Options for Intel Arria 10 GX Devices



## Related Information

### Transceiver Performance for Intel Arria 10 GX/SX Devices

Provides more information about the transceiver speed grade.



## Maximum Resources

**Table 5. Maximum Resource Counts for Intel Arria 10 GX Devices (GX 160, GX 220, GX 270, GX 320, and GX 480)**

Resource		Product Line				
		GX 160	GX 220	GX 270	GX 320	GX 480
Logic Elements (LE) (K)		160	220	270	320	480
ALM		61,510	80,330	101,620	119,900	183,590
Register		246,040	321,320	406,480	479,600	734,360
Memory (Kb)	M20K	8,800	11,740	15,000	17,820	28,620
	MLAB	1,050	1,690	2,452	2,727	4,164
Variable-precision DSP Block		156	192	830	985	1,368
18 x 19 Multiplier		312	384	1,660	1,970	2,736
PLL	Fractional Synthesis	6	6	8	8	12
	I/O	6	6	8	8	12
17.4 Gbps Transceiver		12	12	24	24	36
GPIO <sup>(3)</sup>		288	288	384	384	492
LVDS Pair <sup>(4)</sup>		120	120	168	168	222
PCIe Hard IP Block		1	1	2	2	2
Hard Memory Controller		6	6	8	8	12

<sup>(3)</sup> The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.

<sup>(4)</sup> Each LVDS I/O pair can be used as differential input or output.

**Table 8. Package Plan for Intel Arria 10 GX Devices (F34, F35, NF40, and KF40)**

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

Product Line	F34 (35 mm × 35 mm, 1152-pin FBGA)			F35 (35 mm × 35 mm, 1152-pin FBGA)			KF40 (40 mm × 40 mm, 1517-pin FBGA)			NF40 (40 mm × 40 mm, 1517-pin FBGA)		
	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR
GX 270	48	336	24	48	336	24	—	—	—	—	—	—
GX 320	48	336	24	48	336	24	—	—	—	—	—	—
GX 480	48	444	24	48	348	36	—	—	—	—	—	—
GX 570	48	444	24	48	348	36	96	600	36	48	540	48
GX 660	48	444	24	48	348	36	96	600	36	48	540	48
GX 900	—	504	24	—	—	—	—	—	—	—	600	48
GX 1150	—	504	24	—	—	—	—	—	—	—	600	48

**Table 9. Package Plan for Intel Arria 10 GX Devices (RF40, NF45, SF45, and UF45)**

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

Product Line	RF40 (40 mm × 40 mm, 1517-pin FBGA)			NF45 (45 mm × 45 mm) 1932-pin FBGA)			SF45 (45 mm × 45 mm) 1932-pin FBGA)			UF45 (45 mm × 45 mm) 1932-pin FBGA)		
	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR
GX 900	—	342	66	—	768	48	—	624	72	—	480	96
GX 1150	—	342	66	—	768	48	—	624	72	—	480	96

### Related Information

[I/O and High-Speed Differential I/O Interfaces in Intel Arria 10 Devices chapter, Intel Arria 10 Device Handbook](#)

Provides the number of 3 V and LVDS I/Os, and LVDS channels for each Intel Arria 10 device package.

## Intel Arria 10 GT

This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 GT devices.

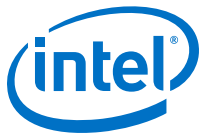
The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

### Related Information

[Intel FPGA Product Selector](#)

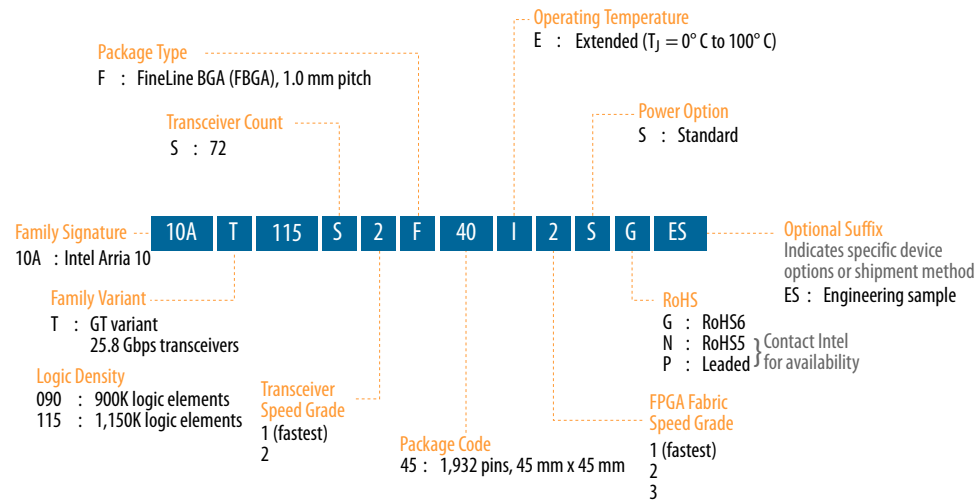
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## Available Options

Figure 2. Sample Ordering Code and Available Options for Intel Arria 10 GT Devices





## Maximum Resources

**Table 10. Maximum Resource Counts for Intel Arria 10 GT Devices**

Resource		Product Line	
		GT 900	GT 1150
Logic Elements (LE) (K)		900	1,150
ALM		339,620	427,200
Register		1,358,480	1,708,800
Memory (Kb)	M20K	48,460	54,260
	MLAB	9,386	12,984
Variable-precision DSP Block		1,518	1,518
18 x 19 Multiplier		3,036	3,036
PLL	Fractional Synthesis	32	32
	I/O	16	16
Transceiver	17.4 Gbps	72 <sup>(5)</sup>	72 <sup>(5)</sup>
	25.8 Gbps	6	6
GPIO <sup>(6)</sup>		624	624
LVDS Pair <sup>(7)</sup>		312	312
PCIe Hard IP Block		4	4
Hard Memory Controller		16	16

### Related Information

#### Intel Arria 10 GT Channel Usage

Configuring GT/GX channels in Intel Arria 10 GT devices.

## Package Plan

**Table 11. Package Plan for Intel Arria 10 GT Devices**

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

Product Line	SF45 (45 mm x 45 mm, 1932-pin FBGA)		
	3 V I/O	LVDS I/O	XCVR
GT 900	—	624	72
GT 1150	—	624	72

<sup>(5)</sup> If all 6 GT channels are in use, 12 of the GX channels are not usable.

<sup>(6)</sup> The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.

<sup>(7)</sup> Each LVDS I/O pair can be used as differential input or output.



## I/O Vertical Migration for Intel Arria 10 Devices

**Figure 4. Migration Capability Across Intel Arria 10 Product Lines**

- The arrows indicate the migration paths. The devices included in each vertical migration path are shaded. Devices with fewer resources in the same path have lighter shades.
- To achieve the full I/O migration across product lines in the same migration path, restrict I/Os and transceivers usage to match the product line with the lowest I/O and transceiver counts.
- An LVDS I/O bank in the source device may be mapped to a 3 V I/O bank in the target device. To use memory interface clock frequency higher than 533 MHz, assign external memory interface pins only to banks that are LVDS I/O in both devices.
- There may be nominal 0.15 mm package height difference between some product lines in the same package type.
- Some migration paths are not shown in the Intel Quartus Prime software **Pin Migration View**.

Variant	Product Line	Package										
		U19	F27	F29	F34	F35	KF40	NF40	RF40	NF45	SF45	UF45
Intel® Arria® 10 GX	GX 160	↑	↑	↑								
	GX 220	↓	↓	↓								
	GX 270		↓	↓	↑	↑						
	GX 320		↓	↓	↑	↑						
	GX 480			↓	↑	↑						
	GX 570				↑	↑	↑	↑				
	GX 660				↑	↑	↑	↑	↑	↑	↑	↑
	GX 900				↑			↑	↑	↑	↑	↑
	GX 1150				↑			↑	↑	↑	↑	↑
	GT 900										↑	↑
	GT 1150										↓	↓
Intel Arria 10 SX	SX 160	↑	↑	↑								
	SX 220	↓	↓	↓								
	SX 270		↓	↓	↑	↑						
	SX 320		↓	↓	↑	↑						
	SX 480			↓	↑	↑						
	SX 570				↑	↑	↑	↑				
	SX 660				↑	↑	↑	↑				

**Note:** To verify the pin migration compatibility, use the **Pin Migration View** window in the Intel Quartus Prime software Pin Planner.

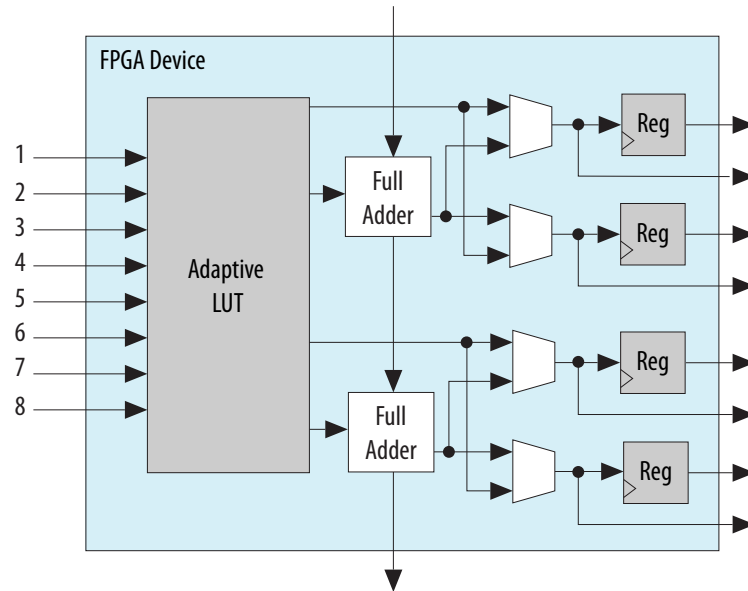
## Adaptive Logic Module

Intel Arria 10 devices use a 20 nm ALM as the basic building block of the logic fabric.

The ALM architecture is the same as the previous generation FPGAs, allowing for efficient implementation of logic functions and easy conversion of IP between the device generations.

The ALM, as shown in following figure, uses an 8-input fracturable look-up table (LUT) with four dedicated registers to help improve timing closure in register-rich designs and achieve an even higher design packing capability than the traditional two-register per LUT architecture.

**Figure 5. ALM for Intel Arria 10 Devices**



The Intel Quartus Prime software optimizes your design according to the ALM logic structure and automatically maps legacy designs into the Intel Arria 10 ALM architecture.

## Variable-Precision DSP Block

The Intel Arria 10 variable precision DSP blocks support fixed-point arithmetic and floating-point arithmetic.

Features for fixed-point arithmetic:

- High-performance, power-optimized, and fully registered multiplication operations
- 18-bit and 27-bit word lengths
- Two 18 x 19 multipliers or one 27 x 27 multiplier per DSP block
- Built-in addition, subtraction, and 64-bit double accumulation register to combine multiplication results
- Cascading 19-bit or 27-bit when pre-adder is disabled and cascading 18-bit when pre-adder is used to form the tap-delay line for filtering applications
- Cascading 64-bit output bus to propagate output results from one block to the next block without external logic support
- Hard pre-adder supported in 19-bit and 27-bit modes for symmetric filters
- Internal coefficient register bank in both 18-bit and 27-bit modes for filter implementation
- 18-bit and 27-bit systolic finite impulse response (FIR) filters with distributed output adder
- Biased rounding support



Features for floating-point arithmetic:

- A completely hardened architecture that supports multiplication, addition, subtraction, multiply-add, and multiply-subtract
- Multiplication with accumulation capability and a dynamic accumulator reset control
- Multiplication with cascade summation capability
- Multiplication with cascade subtraction capability
- Complex multiplication
- Direct vector dot product
- Systolic FIR filter

**Table 15. Variable-Precision DSP Block Configurations for Intel Arria 10 Devices**

Usage Example	Multiplier Size (Bit)	DSP Block Resources
Medium precision fixed point	Two 18 x 19	1
High precision fixed or Single precision floating point	One 27 x 27	1
Fixed point FFTs	One 19 x 36 with external adder	1
Very high precision fixed point	One 36 x 36 with external adder	2
Double precision floating point	One 54 x 54 with external adder	4

**Table 16. Resources for Fixed-Point Arithmetic in Intel Arria 10 Devices**

The table lists the variable-precision DSP resources by bit precision for each Intel Arria 10 device.

Variant	Product Line	Variable-precision DSP Block	Independent Input and Output Multiplications Operator		18 x 19 Multiplier Adder Sum Mode	18 x 18 Multiplier Adder Summed with 36 bit Input
			18 x 19 Multiplier	27 x 27 Multiplier		
Intel Arria 10 GX	GX 160	156	312	156	156	156
	GX 220	192	384	192	192	192
	GX 270	830	1,660	830	830	830
	GX 320	984	1,968	984	984	984
	GX 480	1,368	2,736	1,368	1,368	1,368
	GX 570	1,523	3,046	1,523	1,523	1,523
	GX 660	1,687	3,374	1,687	1,687	1,687
	GX 900	1,518	3,036	1,518	1,518	1,518
	GX 1150	1,518	3,036	1,518	1,518	1,518
Intel Arria 10 GT	GT 900	1,518	3,036	1,518	1,518	1,518
	GT 1150	1,518	3,036	1,518	1,518	1,518
Intel Arria 10 SX	SX 160	156	312	156	156	156
	SX 220	192	384	192	192	192
	SX 270	830	1,660	830	830	830

*continued...*

Figure 6. Intel Arria 10 Transceiver Block Architecture



## Transceiver Channels

All transceiver channels feature a dedicated Physical Medium Attachment (PMA) and a hardened Physical Coding Sublayer (PCS).

- The PMA provides primary interfacing capabilities to physical channels.
- The PCS typically handles encoding/decoding, word alignment, and other pre-processing functions before transferring data to the FPGA core fabric.

A transceiver channel consists of a PMA and a PCS block. Most transceiver banks have 6 channels. There are some transceiver banks that contain only 3 channels.

A wide variety of bonded and non-bonded data rate configurations is possible using a highly configurable clock distribution network. Up to 80 independent transceiver data rates can be configured.

The following figures are graphical representations of top views of the silicon die, which correspond to reverse views for flip chip packages. Different Intel Arria 10 devices may have different floorplans than the ones shown in the figures.



Figure 7. Device Chip Overview for Intel Arria 10 GX and GT Devices



Figure 8. Device Chip Overview for Intel Arria 10 SX Devices



## PMA Features

Intel Arria 10 transceivers provide exceptional signal integrity at data rates up to 25.8 Gbps. Clocking options include ultra-low jitter ATX PLLs (LC tank based), clock multiplier unit (CMU) PLLs, and fractional PLLs.



Each transceiver channel contains a channel PLL that can be used as the CMU PLL or clock data recovery (CDR) PLL. In CDR mode, the channel PLL recovers the receiver clock and data in the transceiver channel. Up to 80 independent data rates can be configured on a single Intel Arria 10 device.

**Table 23. PMA Features of the Transceivers in Intel Arria 10 Devices**

Feature	Capability
Chip-to-Chip Data Rates	1 Gbps to 17.4 Gbps (Intel Arria 10 GX devices) 1 Gbps to 25.8 Gbps (Intel Arria 10 GT devices)
Backplane Support	Drive backplanes at data rates up to 12.5 Gbps
Optical Module Support	SFP+/SFP, XFP, CXP, QSFP/QSFP28, CFP/CFP2/CFP4
Cable Driving Support	SFP+ Direct Attach, PCI Express over cable, eSATA
Transmit Pre-Emphasis	4-tap transmit pre-emphasis and de-emphasis to compensate for system channel loss
Continuous Time Linear Equalizer (CTLE)	Dual mode, high-gain, and high-data rate, linear receive equalization to compensate for system channel loss
Decision Feedback Equalizer (DFE)	7-fixed and 4-floating tap DFE to equalize backplane channel loss in the presence of crosstalk and noisy environments
Variable Gain Amplifier	Optimizes the signal amplitude prior to the CDR sampling and operates in fixed and adaptive modes
Altera Digital Adaptive Parametric Tuning (ADAPT)	Fully digital adaptation engine to automatically adjust all link equalization parameters—including CTLE, DFE, and variable gain amplifier blocks—that provide optimal link margin without intervention from user logic
Precision Signal Integrity Calibration Engine (PreSICE)	Hardened calibration controller to quickly calibrate all transceiver control parameters on power-up, which provides the optimal signal integrity and jitter performance
Advanced Transmit (ATX) PLL	Low jitter ATX (LC tank based) PLLs with continuous tuning range to cover a wide range of standard and proprietary protocols
Fractional PLLs	On-chip fractional frequency synthesizers to replace on-board crystal oscillators and reduce system cost
Digitally Assisted Analog CDR	Superior jitter tolerance with fast lock time
Dynamic Partial Reconfiguration	Allows independent control of the Avalon memory-mapped interface of each transceiver channel for the highest transceiver flexibility
Multiple PCS-PMA and PCS-PLD interface widths	8-, 10-, 16-, 20-, 32-, 40-, or 64-bit interface widths for flexibility of deserialization width, encoding, and reduced latency

## PCS Features

This table summarizes the Intel Arria 10 transceiver PCS features. You can use the transceiver PCS to support a wide range of protocols ranging from 1 Gbps to 25.8 Gbps.





PCS	Description
Standard PCS	<ul style="list-style-type: none"> <li>Operates at a data rate up to 12 Gbps</li> <li>Supports protocols such as PCI-Express, CPRI 4.2+, GigE, IEEE 1588 in Hard PCS</li> <li>Implements other protocols using Basic/Custom (Standard PCS) transceiver configuration rules.</li> </ul>
Enhanced PCS	<ul style="list-style-type: none"> <li>Performs functions common to most serial data industry standards, such as word alignment, encoding/decoding, and framing, before data is sent or received off-chip through the PMA</li> <li>Handles data transfer to and from the FPGA fabric</li> <li>Handles data transfer internally to and from the PMA</li> <li>Provides frequency compensation</li> <li>Performs channel bonding for multi-channel low skew applications</li> </ul>
PCIe Gen3 PCS	<ul style="list-style-type: none"> <li>Supports the seamless switching of Data and Clock between the Gen1, Gen2, and Gen3 data rates</li> <li>Provides support for PIPE 3.0 features</li> <li>Supports the PIPE interface with the Hard IP enabled, as well as with the Hard IP bypassed</li> </ul>

### Related Information

- [PCIe Gen1, Gen2, and Gen3 Hard IP](#) on page 26
- [Interlaken Support](#) on page 26
- [10 Gbps Ethernet Support](#) on page 26

## PCS Protocol Support

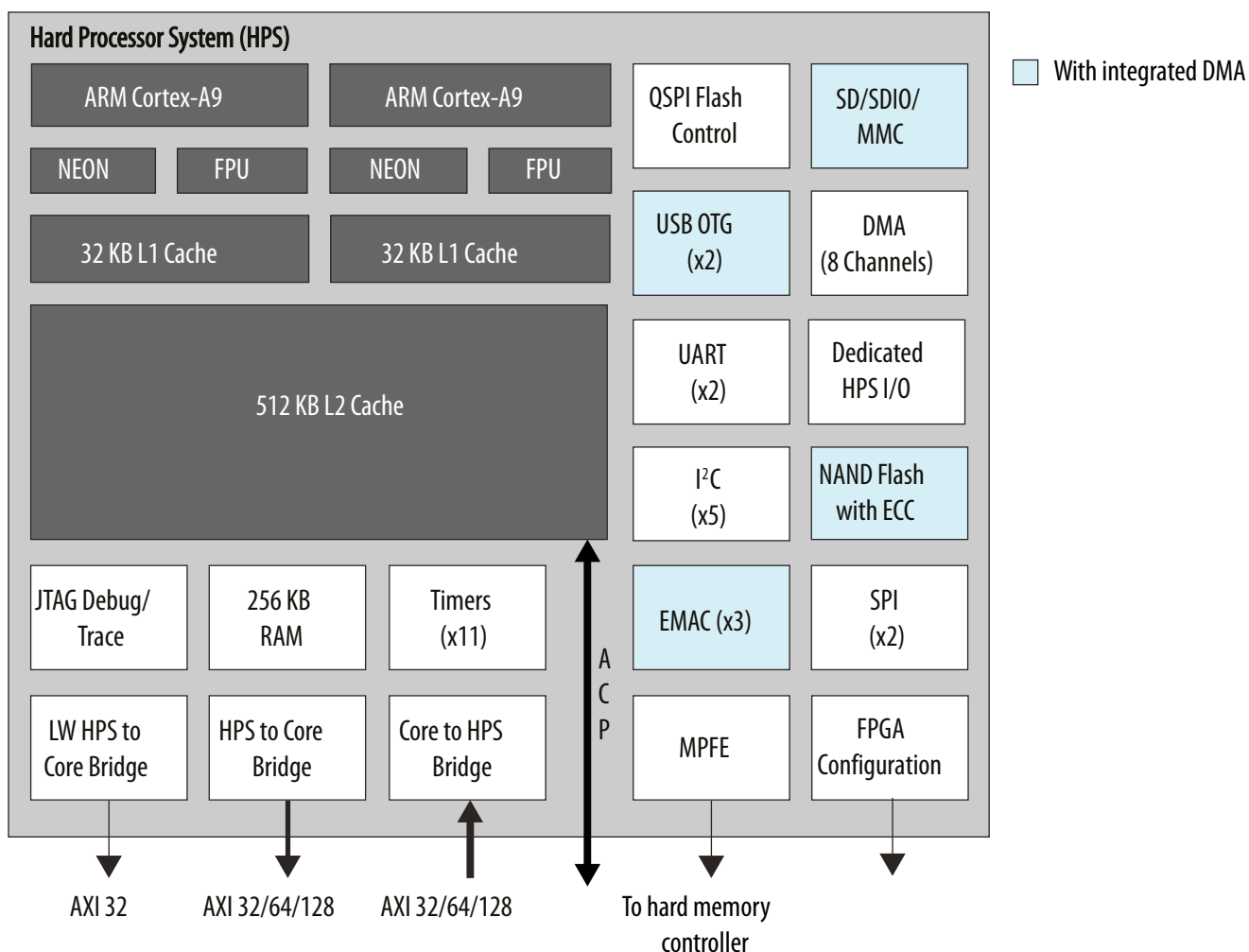
This table lists some of the protocols supported by the Intel Arria 10 transceiver PCS. For more information about the blocks in the transmitter and receiver data paths, refer to the related information.

Protocol	Data Rate (Gbps)	Transceiver IP	PCS Support
PCIe Gen3 x1, x2, x4, x8	8.0	Native PHY (PIPE)	Standard PCS and PCIe Gen3 PCS
PCIe Gen2 x1, x2, x4, x8	5.0	Native PHY (PIPE)	Standard PCS
PCIe Gen1 x1, x2, x4, x8	2.5	Native PHY (PIPE)	Standard PCS
1000BASE-X Gigabit Ethernet	1.25	Native PHY	Standard PCS
1000BASE-X Gigabit Ethernet with IEEE 1588v2	1.25	Native PHY	Standard PCS
10GBASE-R	10.3125	Native PHY	Enhanced PCS
10GBASE-R with IEEE 1588v2	10.3125	Native PHY	Enhanced PCS
10GBASE-R with KR FEC	10.3125	Native PHY	Enhanced PCS
10GBASE-KR and 1000BASE-X	10.3125	1G/10GbE and 10GBASE-KR PHY	Standard PCS and Enhanced PCS
Interlaken (CEI-6G/11G)	3.125 to 17.4	Native PHY	Enhanced PCS
SFI-S/SFI-5.2	11.2	Native PHY	Enhanced PCS
10G SDI	10.692	Native PHY	Enhanced PCS
continued...			



**Figure 9. HPS Block Diagram**

This figure shows a block diagram of the HPS with the dual ARM Cortex-A9 MPCore processor.



## Key Advantages of 20-nm HPS

The 20-nm HPS strikes a balance between enabling maximum software compatibility with 28-nm SoCs while still improving upon the 28-nm HPS architecture. These improvements address the requirements of the next generation target markets such as wireless and wireline communications, compute and storage equipment, broadcast and military in terms of performance, memory bandwidth, connectivity via backplane and security.



## Features of the HPS

The HPS has the following features:

- 1.2-GHz, dual-core ARM Cortex-A9 MPCore processor with up to 1.5-GHz via overdrive
  - ARMv7-A architecture that runs 32-bit ARM instructions, 16-bit and 32-bit Thumb instructions, and 8-bit Java byte codes in Jazelle style
  - Superscalar, variable length, out-of-order pipeline with dynamic branch prediction
  - Instruction Efficiency 2.5 MIPS/MHz, which provides total performance of 7500 MIPS at 1.5 GHz
- Each processor core includes:
  - 32 KB of L1 instruction cache, 32 KB of L1 data cache
  - Single- and double-precision floating-point unit and NEON media engine
  - CoreSight debug and trace technology
  - Snoop Control Unit (SCU) and Acceleration Coherency Port (ACP)
- 512 KB of shared L2 cache
- 256 KB of scratch RAM
- Hard memory controller with support for DDR3, DDR4 and optional error correction code (ECC) support
- Multiport Front End (MPFE) Scheduler interface to the hard memory controller
- 8-channel direct memory access (DMA) controller
- QSPI flash controller with SIO, DIO, QIO SPI Flash support
- NAND flash controller (ONFI 1.0 or later) with DMA and ECC support, updated to support 8 and 16-bit Flash devices and new command DMA to offload CPU for fast power down recovery
- Updated SD/SDIO/MMC controller to eMMC 4.5 with DMA with CE-ATA digital command support
- 3 10/100/1000 Ethernet media access control (MAC) with DMA
- 2 USB On-the-Go (OTG) controllers with DMA
- 5 I<sup>2</sup>C controllers (3 can be used by EMAC for MIO to external PHY)
- 2 UART 16550 Compatible controllers
- 4 serial peripheral interfaces (SPI) (2 Master, 2 Slaves)
- 62 programmable general-purpose I/Os, which includes 48 direct share I/Os that allows the HPS peripherals to connect directly to the FPGA I/Os
- 7 general-purpose timers
- 4 watchdog timers
- Anti-tamper, Secure Boot, Encryption (AES) and Authentication (SHA)



## FPGA Configuration and HPS Booting

The FPGA fabric and HPS in the SoC FPGA must be powered at the same time. You can reduce the clock frequencies or gate the clocks to reduce dynamic power.

Once powered, the FPGA fabric and HPS can be configured independently thus providing you with more design flexibility:

- You can boot the HPS independently. After the HPS is running, the HPS can fully or partially reconfigure the FPGA fabric at any time under software control. The HPS can also configure other FPGAs on the board through the FPGA configuration controller.
- Configure the FPGA fabric first, and then boot the HPS from memory accessible to the FPGA fabric.

## Hardware and Software Development

For hardware development, you can configure the HPS and connect your soft logic in the FPGA fabric to the HPS interfaces using the Platform Designer system integration tool in the Intel Quartus Prime software.

For software development, the ARM-based SoC FPGA devices inherit the rich software development ecosystem available for the ARM Cortex-A9 MPCore processor. The software development process for Intel SoC FPGAs follows the same steps as those for other SoC devices from other manufacturers. Support for Linux\*, VxWorks\*, and other operating systems are available for the SoC FPGAs. For more information on the operating systems support availability, contact the Intel FPGA sales team.

You can begin device-specific firmware and software development on the Intel SoC FPGA Virtual Target. The Virtual Target is a fast PC-based functional simulation of a target development system—a model of a complete development board. The Virtual Target enables the development of device-specific production software that can run unmodified on actual hardware.

## Dynamic and Partial Reconfiguration

The Intel Arria 10 devices support dynamic and partial reconfiguration. You can use dynamic and partial reconfiguration simultaneously to enable seamless reconfiguration of both the device core and transceivers.

### Dynamic Reconfiguration

You can reconfigure the PMA and PCS blocks while the device continues to operate. This feature allows you to change the data rates, protocol, and analog settings of a channel in a transceiver bank without affecting on-going data transfer in other transceiver banks. This feature is ideal for applications that require dynamic multiprotocol or multirate support.

### Partial Reconfiguration

Using partial reconfiguration, you can reconfigure some parts of the device while keeping the device in operation.



Instead of placing all device functions in the FPGA fabric, you can store some functions that do not run simultaneously in external memory and load them only when required. This capability increases the effective logic density of the device, and lowers cost and power consumption.

In the Intel solution, you do not have to worry about intricate device architecture to perform a partial reconfiguration. The partial reconfiguration capability is built into the Intel Quartus Prime design software, making such time-intensive task simple.

Intel Arria 10 devices support partial reconfiguration in the following configuration options:

- Using an internal host:
  - All supported configuration modes where the FPGA has access to external memory devices such as serial and parallel flash memory.
  - Configuration via Protocol [CvP (PCIe)]
- Using an external host—passive serial (PS), fast passive parallel (FPP) x8, FPP x16, and FPP x32 I/O interface.

## Enhanced Configuration and Configuration via Protocol

**Table 25. Configuration Schemes and Features of Intel Arria 10 Devices**

Intel Arria 10 devices support 1.8 V programming voltage and several configuration schemes.

Scheme	Data Width	Max Clock Rate (MHz)	Max Data Rate (Mbps) <sup>(13)</sup>	Decompression	Design Security <sup>(14)</sup>	Partial Reconfiguration <sup>(15)</sup>	Remote System Update
JTAG	1 bit	33	33	—	—	Yes <sup>(16)</sup>	—
Active Serial (AS) through the EPCQ-L configuration device	1 bit, 4 bits	100	400	Yes	Yes	Yes <sup>(16)</sup>	Yes
Passive serial (PS) through CPLD or external microcontroller	1 bit	100	100	Yes	Yes	Yes <sup>(16)</sup>	Parallel Flash Loader (PFL) IP core

*continued...*

<sup>(13)</sup> Enabling either compression or design security features affects the maximum data rate. Refer to the Intel Arria 10 Device Datasheet for more information.

<sup>(14)</sup> Encryption and compression cannot be used simultaneously.

<sup>(15)</sup> Partial reconfiguration is an advanced feature of the device family. If you are interested in using partial reconfiguration, contact Intel for support.

<sup>(16)</sup> Partial configuration can be performed only when it is configured as internal host.